UNR6221/6222/6223/6224 (UN6221/6222/6223/6224)

Silicon NPN epitaxial planer transistor

For digital circuits

Features

- Costs can be reduced through downsizing of the equipment and reduction of the number of parts.
- MT-1 type package, allowing supply with the radial taping.

Resistance by Part Number				
	(R ₁)	(R ₂)		
• UNR6221	$2.2k\Omega$	$2.2k\Omega$		
• UNR6222	$4.7 \mathrm{k}\Omega$	$4.7 \mathrm{k}\Omega$		
• UNR6223	$10k\Omega$	$10k\Omega$		
• UNR6224	$2.2k\Omega$	$10k\Omega$		



Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Collector to base voltage	V _{CBO}	50	V
Collector to emitter voltage	V _{CEO}	50	V
Collector current	I _C	500	mA
Total power dissipation	P _T	600	mW
Junction temperature	Tj	150	°C
Storage temperature	T _{stg}	-55 to +150	°C

Internal Connection



Note) The Part numbers in the Parenthesis show conventional part number.

Parameter Symbol Conditions Unit min typ max $V_{CB} = 50V, I_E = 0$ 1 μΑ I_{CBO} Collector cutoff current $V_{CE} = 50V, I_B = 0$ 1 μΑ I_{CEO} UNR6221 5 Emitter UNR6222 $V_{EB} = 6V, I_C = 0$ 2 mA I_{EBO} cutoff current UNR6223/6224 1 Collector to base voltage V_{CBO} $I_{C} = 10 \mu A, I_{E} = 0$ 50 V $I_C = 2mA$, $I_B = 0$ V 50 Collector to emitter voltage V_{CEO} Forward UNR6221 40 current UNR6222 $V_{CE} = 10V, I_C = 100mA$ 50 h_{FE} transfer UNR6223/6224 60 ratio Collector to emitter saturation voltage V_{CE(sat)} $I_C = 100 \text{mA}, \text{IB} = 5 \text{mA}$ 0.25 V v $V_{CC} = 5V, V_B = 0.5V, R_L = 500\Omega$ 4.9 Output voltage high level VOH Output voltage low level $V_{CC} = 5V, V_B = 3.5V, R_L = 500\Omega$ 0.2 V V_{OL} Transition frequency \mathbf{f}_{T} $V_{CB} = 10V, I_E = -50mA, f = 200MHz$ 200 MHz UNR6221/6224 2.2 Input UNR6222 (-30%) kΩ R_1 4.7 (+30%) resistance UNR6223 10 Resistance ratio 1.0 0.8 1.2 R_1/R_2 UNR6224 0.17 0.22 0.27

Electrical Characteristics (Ta=25°C)



















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Characteristics charts of UNR6222





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